

Title (en)

COMPONENT WITH MICROFLUIDIC STRUCTURES, METHOD FOR THE PRODUCTION AND USE THEREOF

Title (de)

BAUTEIL MIT MIKROFLUIDIKSTRUKTUREN, HERSTELLUNGSVERFAHREN UND VERWENDUNG

Title (fr)

COMPOSANT À STRUCTURES MICROFLUIDIQUES, SON PROCÉDÉ DE PRODUCTION ET SON UTILISATION

Publication

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Application

**EP 21719557 A 20210413**

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Abstract (en)

[origin: WO2021244796A1] The invention relates to a method for producing a component having a microfluidic structure, said method comprising the following steps: embossing depressions in an embossing lacquer layer, partially curing the embossing lacquer layer, sealing the depressions with a curable bonding lacquer layer and curing the partially cured embossing lacquer layer and the bonding lacquer layer. The invention also relates to a component obtainable according to said method and to the use of said component.

IPC 8 full level

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See references of WO 2021244796A1

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